



Technical Data Sheet¹

Material CURABOND FX 2065

Polymer Reactive

Melting Range 98 -115°C (Kofler)

Melting Point DSC 95.6°C

Melt Index

130°C 15kg	12
190°C	Unable to test

Fusing Conditions (may vary according to substrate) Cross-Linking

Temperature	130-170°C	165-190°C
Time	10-25 seconds	30-90 seconds
Pressure	2-5 bar	
Washable to	95°C (when post-cured)	
Heat Resistance	Excellent (when post-cured)	

Typical applications:

High performance apparel and technical automotive applications. Product bonds to a wide range of surfaces including foam, aluminium foil, polyaramid, fluorinated and siliconised substrates. Optimum results are achieved when a post-cure operation is involved.

¹ Our only obligation shall be to replace or pay for any material proved defective. Beyond the purchase price of materials supplied by us we assume no liability for damages of any kind and the user accepts the product "as is" and without Warranties expressed or implied. The suitability of the product for an intended use shall be solely up to the user and checked by them under recommended conditions.